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**Title of  
Invention****METHOD AND SYSTEM FOR DYNAMIC MODELING AND RECIPE  
OPTIMIZATION OF SEMICONDUCTOR ETCH PROCESSES**

Application Number : 10/523777



Date : 2005-07-08

First Named Applicant: Li Kun

Confirmation Number: 5732

Attorney Docket Number: VOY007US

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Joseph R. Jordan Registered Number: 25,686	/Joseph R. Jordan/	Attorney

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